SH

MODEL NO. : TM020GDH03

ISSUED DATE: <u>2008-12-09</u>

VERSION : ___Ver 1.0

■ Preliminary Specification ☐ Final Product Specification

Customer	•			
	Approv	ed by	Notes	

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by
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This technical specification is subjected to change without notice





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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2008-12-09	Preliminary Release	Jianbin Zhu

1 General Specifications

	Feature	Spec		
	Size	2.0 inch		
	Resolution	176(RGB) x 220		
	Interface	CPU 16 /8 Bits		
	Color Depth	262K/65K		
	Technology Type	a-Si		
Display Spec	Pixel Pitch (mm)	0.180x0.180		
	Pixel Configuration	R.G.B. Vertical Stripe		
	Display Mode	TM With Normally White		
	Surface Treatment(Up Polarizer)	Clear Type (3H)		
	Viewing Direction	6 o'clock		
	Gray Scale Inversion Direction	12 o'clock		
	LCM (W x H x D) (mm)	38.03 x 51.65x2.50		
Maabaaiaal	Active Area(mm)	31.68x39.60		
Mechanical Characteristics	With /Without TSP	Without TSP		
	Weight (g)	8.15		
	LED Numbers	3 LEDs		
Electronic	Driver IC	HX8340-B		

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS

Note 3: LCM weight tolerance: +/- 5%



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O/P	Description	Remark
1	DB15	I	Data Bus	
2	DB14	I	Data Bus	
3	DB13	I	Data Bus	
4	DB12	I	Data Bus	
5	DB11	I	Data Bus	
6	DB10	I	Data Bus	
7	DB9	I	Data Bus	
8	DB8	I	Data Bus	
9	GND	Р	Ground	
10	DB7	I	Data Bus	
11	DB6	I	Data Bus	
12	DB5	I	Data Bus	
13	DB4	I	Data Bus	
14	DB3	I	Data Bus	
15	DB2	I	Data Bus	
16	DB1	I	Data Bus	
17	DB0	I	Data Bus	
18	IOVCC	Р	Logical I/O Power Supply	
19	VCC	Р	Drive Power Supply	
20	/RD	I	Read Signal	Active Low
21	/WR	I	Write Signal	Active Low
22	RS	I	Register Select	Low Index High Register
23	/CS	I	Chip Select Signal	Active Low
24	/RESET	I	Reset Signal	Active Low
25	IM0	I	Mode Select Low: 16bits High: 8bits	
26	GND	Р	Ground	
27	LED_A	Р	Anode of LED	
28	LED_K1	Р	Cathode of LED	



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29	LED_K2	Р	Cathode of LED	
30	LED_K3	Р	Cathode of LED	
31	Y+		No Connection	
32	Y-		No Connection	
33	X+		No Connection	
34	X-		No Connection	
35	NC		No Connection	
36	NC		No Connection	

Note: I/O Definition:

I----Input O----Output P----Power/Ground



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V,Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	3.6	V	
Analog Supply Voltage	VCC	-0.3	4.2	V	
Logic Input Signal Voltage	DB0~DB15, /CS RS,/WR,/RD /RESET,IM0	-0.3	IOVCC+0.5	V	
Back Light Forward Current	I _{LED}		25	mA	For Each LED
Operating Temperature	T _{OPR}	-20	70	${\mathbb C}$	
Storage Temperature	T _{STG}	-30	80	$^{\circ}$	

4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

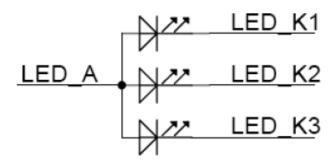
Item		Symbol	Min	Тур	Max	Unit	Remark
Logic Suppl	y Voltage	IOVCC	2.5	2.8	3.3	V	
Analog Supp	ly Voltage	VCC	2.5	2.8	3.3	V	
Input Signal	Low Level	VIL	0		0.2xIOVCC	V	DB0~DB15 /CS,RS,/WR
Voltage	High Level	VIH	0.8xIOVCC		IOVCC	V	/RD,/RESET IM0
Output Signal	Low Level	V_{OL}	-0.3	-	0.2xIOVCC	V	
Voltage	High Level	Vон	0.8xIOVCC		IOVCC	V	
(Panel+ LSI) Power Consumption		Black Mode (60Hz)		7.85	13.50	mW	
		Sleeping Mode		22.5	26.5	μW	

4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I _F		15		mA	For each LED
Forward Voltage	V _F		3.2		V	Note1,2,3
Power Consumption	W _{BL}		144		mW	Note 1,2,3

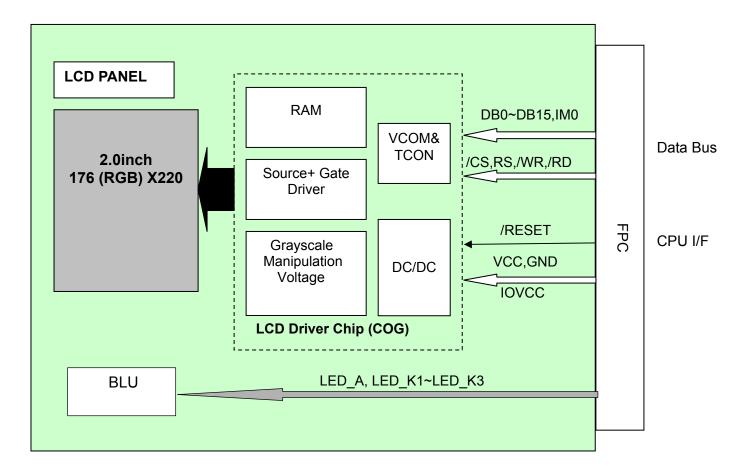
Note 1: The figure below shows the connection of backlight LED.



Note 2: One LED : $I_F = 15$ mA, $V_F = 3.2$ V.

Note 3: The minimal life of LED: 20,000 hours.

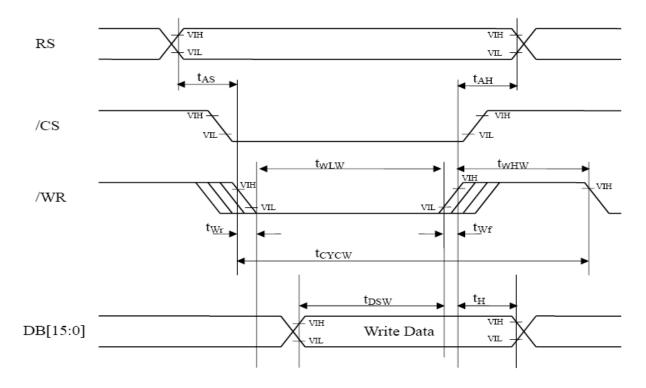
4.3 Block Diagram



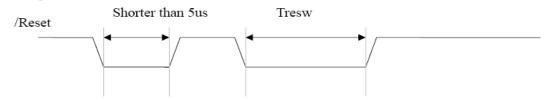
5 Timing Chart

5.1 Timing Parameter

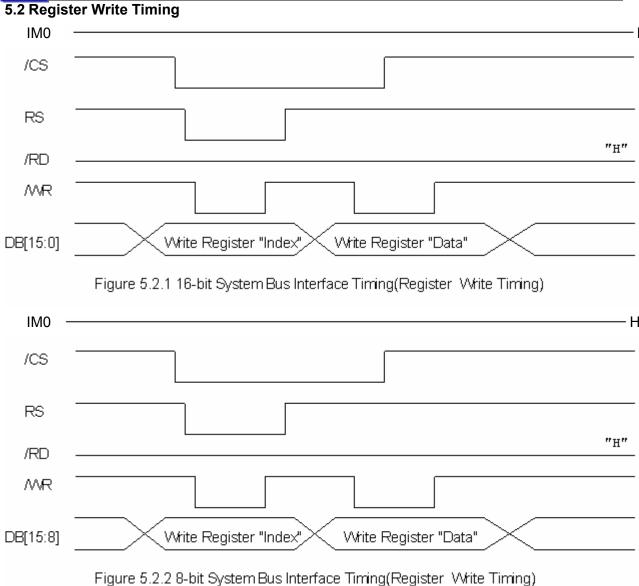
lt	em	Symbol	Unit	Min	Тур	Max
Bus Cycle Time	Write	t _{cycw}	ns	66		
Write Low-level Pu	lse Width	t _{WLW}	ns	15		
Write High-level Pu	t _{whw}	ns	15			
Write Rise/Fall Tim	$t_{Wr,Wf}$	ns			15	
Address Setup Tim	e	t _{AS}	ns	10		
Address Hold Time		t _{AH}	ns	10		
Write Data Setup Time		t _{DSW}	ns	10		
Write Data Hold Time		t _H	ns	10		







Note: Tresw(at least 10us)



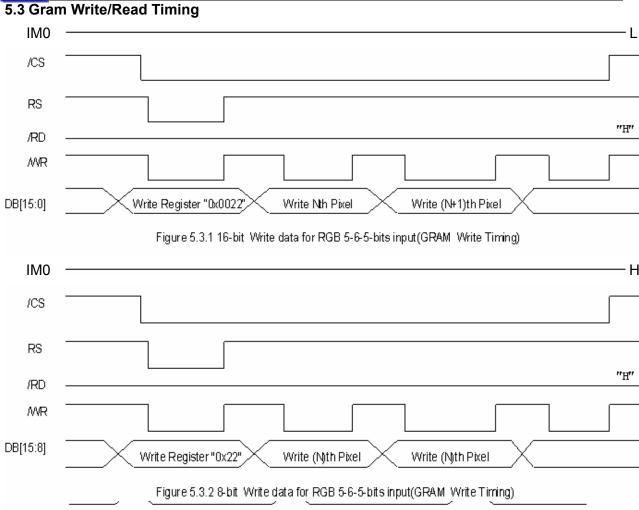


Figure 5.2.2 8-bit System Bus Interface Timing(Register Write Timing)

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5.4 Display Mode

5.4.1. 16-Bit Bus Gram Mode Select

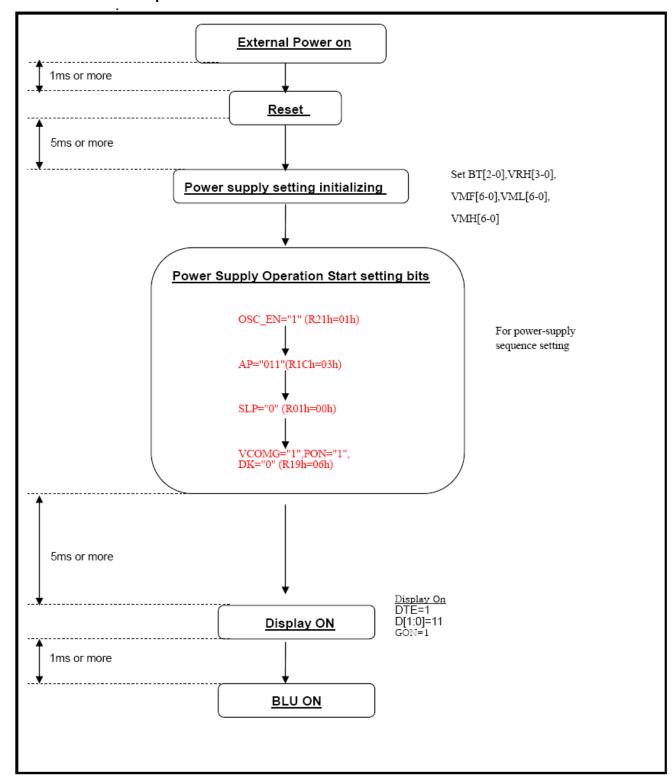
Register	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command
Command	Х	Х	Х	Х	Х	Х	Х	X	0	0	1	0	0	0	1	0	22H
17H	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
03h	X	Х	X	Х	R3	R2	R1	R0	G3	G2	G1	GO	В3	B2	B1	В0	4K-Color
05h	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B4	В3	B2	B1	ВО	65K-Color
	R5	R4	R3	R2	R1	R0	Х	Х	G5	G4	G3	G2	G1	G0	Х	Х	
06h	B5	B4	В3	B2	B1	В0	Х	X	R5	R4	R3	R2	R1	R0	Х	Х	262K-Color
	G5	G4	G3	G2	G1	G0	Х	Х	B5	B4	В3	B2	B1	ВО	Х	X	

5.4.2. 8-Bit Bus Gram Mode Select

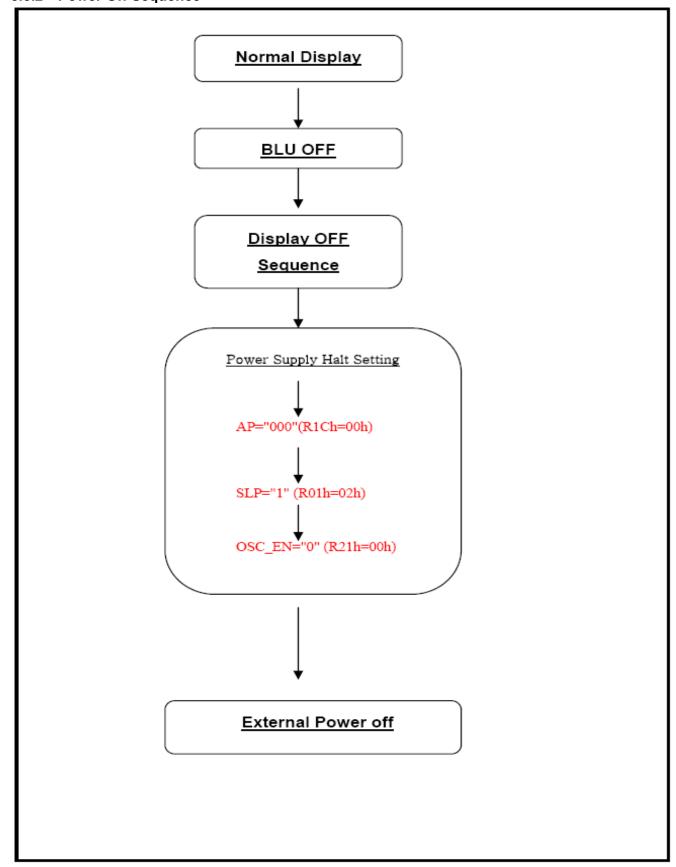
Register	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBO	Command
Command	X	Х	X	Х	Х	Х	X	Х	0	0	1	0	0	0	1	0	22H
17H	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBO	Color
	R3	R2	R1	RO	G3	G2	G1	G0	Х	X	Х	Х	X	X	Х	Х	
	В3	B2	B1	BO	R3	R2	R1	R0									
03h	G3	G2	G1	GO	В3	B2	B1	В0									4K-Color
	R4	R3	R2	R1	R0	G5	G4	G3	Х	X	Х	Х	X	Х	Х	Х	
05h	G2	G1	GO	В4	В3	B2	B1	В0									65K-Color
	R5	R4	R3	R2	R1	R0	Х	Х	Х	X	Х	Х	Х	X	Х	Х	
06h	B5	B4	В3	B2	B1	В0	Х	Х	Х	X	Х	Х	X	Х	Х	Х	262K-Color
	G 5	G4	G3	G2	G1	GO	Х	Х	Х	X	Х	Х	Х	Х	Х	Х	

5.5 Power On/Off Sequence

5.5.1 Power On Sequence



5.5.2 Power Off Sequence



6 Optical Characteristics

6.1 Optical Specification

Ta=25°C

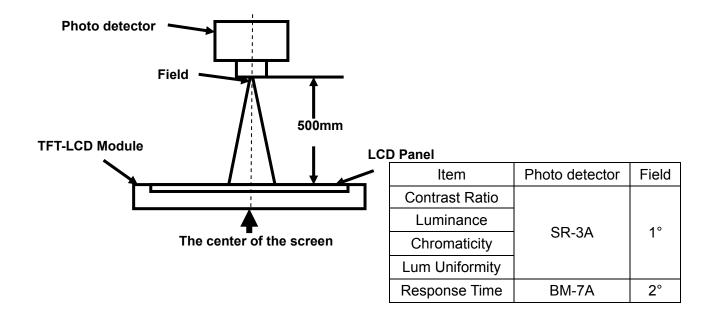
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		50	60			Note 2
View Angles		θВ	CR≧10	45	55		Dagraa	
View Angles		θL		50	60		Degree	
		θR		50	60			
Contrast Ratio)	CR	θ=()°	400	500			Note1 Note3
Response Time		T _{ON}	25℃		25	40	ms	Note1
		T _{OFF}	25 C					Note4
	White	х		0.234	0.284	0.334		Note5 Note1
	VVIIILE	у		0.262	0.312	0.362		
	Red	х		0.561	0.611	0.661		
Chromaticity	rteu	у	Backlight is on	0.288	0.338	0.388		
Chilomaticity	Green	Х		0.274	0.324	0.374		
		у		0.562	0.612	0.662		
	Blue	х		0.095	0.145	0.195		
	Diue	у		0.041	0.091	0.141		
Uniformity		U		75	80		%	Note1 Note6
NTSC				55	60		%	Note 5
Luminance		L		200	220		cd/m ²	Note1 Note7

Test Conditions:

- 1. $V_F = 3.2V$, $I_F = 15$ mA(LED current), the ambient temperature is 25°C.
- 2. The test systems refer to Note 1 and Note 2.

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system. viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

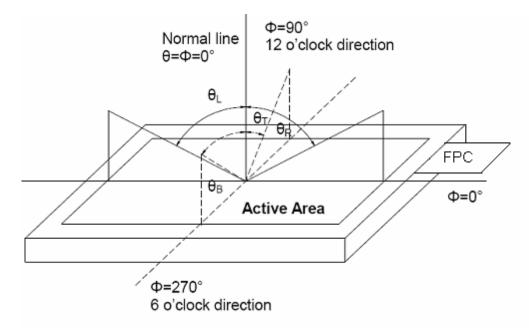


Fig. 1 Definition of viewing angle

Note 3: Definition of contrast ratio

Contrast ratio (CR) = Luminance measured when LCD is on the "White" state

Luminance measured when LCD is on the "Black" state

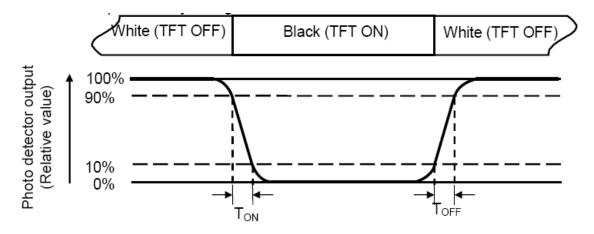
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/ Lmax

L-----Active area length W----- Active area width

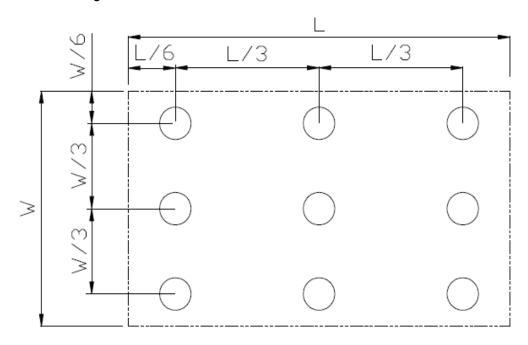


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

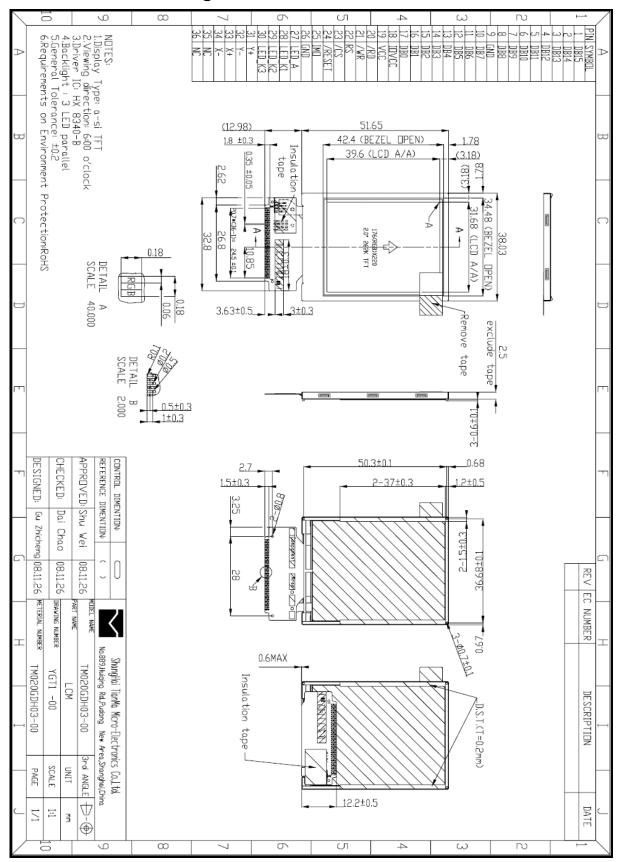
7 Environmental / Reliability Test

No	Test Item	Condition	Remark				
1	High Temperature Operation	Ts=+70℃,240hrs	Note1 IEC60068-2-2,GB2423.2—89				
2	Low Temperature Operation	Ta=-20°C,240hrs	IEC60068-2-1 GB2423.1—89				
3	High Temperature Storage	1a=+80 C,240nrs	IEC60068-2-2, GB2423.2—89				
4	Low Temperature Storage		IEC60068-2-1 GB2423.1—89				
5	High Temperature & High Humidity Storage	Ta=+60°C,90% RH 240 hours.	Note2 IEC60068-2-3, GB/T2423.3—2006				
6	Thermal Shock (Non-Operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87				
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω , oints/panel Air: \pm 8KV, 5times; Contact: \pm 4KV, 5 times; (Environment: 15 $^{\circ}$ C \rightarrow 35 $^{\circ}$ C, 30% \rightarrow 60%, 86Kpa \rightarrow 106Kpa)	IEC61000-4-2 GB/T17626.2—1998				
8	Vibration (Non-Operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition)	IEC60068-2-6 GB/T2423.10—1995				
9	Shock (Non-Operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995				
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995				

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of samples.

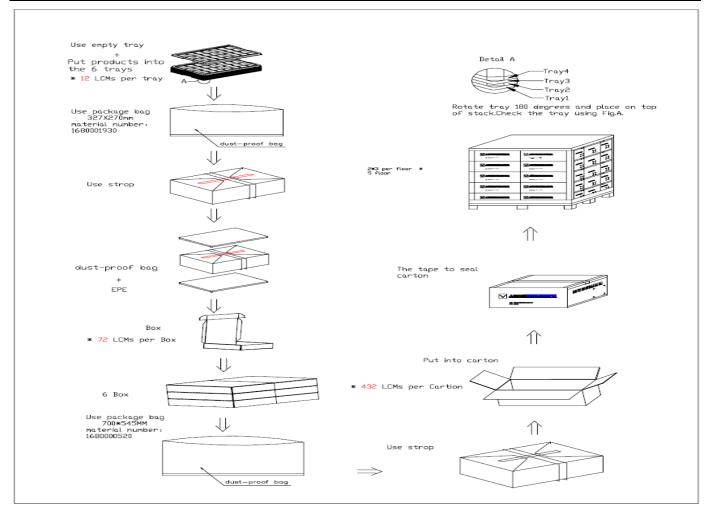
8 Mechanical Drawing



9 Packing Drawing

Packaging Material Table

No	Item	Model (Material)	Dimensions(mm)	Unit Weight (Kg)	Quantity	Remark			
1	LCM Module	TM020GDH03	38.03×51.65×2.5	0.008	432				
2	Tray	PET(Transmit)	315×247×11	0.086	42	Anti-Static			
3	EPE	EPE	315×247×5	0.08	12				
4	Dust-Proof Bag	PE	700×545	0.05	1				
5	Anti-Static Bag	PE	327×270	0.01	6				
6	Box	Corrugate Paper	345×260×70	0.44	6				
7	Carton	Corrugated Paper	544×365×250	1.01	1				
8	Total Weight(Kg)	(11.8±0.6)Kg							



10 Precautions For Use of LCD Modules

10.1 Handling Precautions

The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

- 10.1.1 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.2 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.3 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.4 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
- Isopropyl alcoholEthyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.5 Do not attempt to disassemble the LCD Module.
- 10.1.6 If the logic circuit power is off, do not apply the input signals.
- 10.1.7 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.7.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.7.2 Tools required for assembly, such as soldering irons, must be properly ground.
 - 10.1.7.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - 10.1.7.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage Precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C ~ 40°C Relatively humidity: ≤80%

10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.